



# THURIUU-X4-07E

1U 1/2 MIL-810 MILITARY COMPUTER





- 1U ½ Rugged Military Server
- Intel® Coffee Lake Xeon® E-2276ML
- DDR4 Up to 128GB, NVMe Up to 2TB
- Military D38999 Connectors Support: 2 x mini DP,
   2 x LAN, 2 x USB 3.0
- Design for Naval Defense System , withstand 75G rms Shock
- 9V~36V DC-in, MIL-STD-461 EMI Filter
- Extended Temperature:-40~+70 Degree

## **Specifications**

#### SYSTEM

Processor	Intel® 9th Gen. Xeon® E-2276ML (12M Cache, up to 2.0/4.2 GHz)		
Memory type	4 x DDR4 2666MHz up to 128GB		
Chipset	CM246		
DISPLAY			
Processor Graphics	Intel® UHD Graphics P630		
STORAGE			
Storage(1)	NVMe M.2 up to 2TB		
INTERFACE CAR	RD.		
Digital Input/Output	8 bit digital I/O , split into 2 groups of 4 , Programmable I/O		
FRONT I/O			
X1	1 x DC (Amphenol TV07RW09-98P)		
X2	1 x LAN (Amphenol TV07RW-9-09S)		
X3	1 x LAN (Amphenol TV07RW-9-09S)		
REAR I/O			
X4	1 x Mini DP (Amphenol TV07RW-13-35S)		
X5	1 x Mini DP (Amphenol TV07RW-13-35S)		
X6	1 x USB 3.0 (Amphenol USB3FTV7AZNF312)		
X7	1 x USB 3.0 (Amphenol USB3FTV7AZNF312)		
POWER REQUIR	EMENT		
Power Input	MIL-STD 461 18V~36V		
PHYSICAL			
Dimension (W x D x H)	220 x400 x 44mm		
Chassis	Aluminum Alloy, Corrosion Resistant		
Finish	Anodic aluminum oxide (Color Iron gray)		
Cooling	Natural Passive Convection/Conduction. No Moving Parts		
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Finish	Anodic aluminum oxide (Color Iron gray)		

Cooling	Natural Passive Convection/Conduction. No Moving Parts			
Ingress Protection	IP65			
ENVIRONMENT	AL			
MIL-STD-810 Testin	g Methods (Operating)			
Method 502.5 Procedure 2	Low Temperature	-40°C, 4 hours, ±3°C		
Method 501.5 Procedure 2	High Temperature	+70°C, 4 hours, ±3°C		
Method 507.5	Humidity	85%-95% RH without condensation, 24 hours/ cycle, conduct 10 cycles.		
Method 514.6	Vibration	5-500Hz 5.0 g rms , 30mins by Z axis. 5-500Hz 7.0 g rms , 30mins by X/Y axis		
Method 516.6	Shock	50 g, 11ms.		
MIL-STD-810 Testin	g Methods (None-Opera	ating)		
Method 502.5	Low Temperature (Storage)	-40°C, 4 hours, change rate: ≦20°C/Hour		
Method 501.5	High Temperature (Storage)	+85°C, 4 hours, change rate:≦20°C/ Hour		
Method 514.6	Vibration	5-500Hz 7.0 g rms, 30mins by Z axis. 5-500Hz 10.0 g rms,30mins by X/Y axis		
Method 516.6	Shock	75 g, 6ms.		
MIL-STD-461 Testin	g Methods (EMC)			
CE102 basic curve	Power Leads	10kHz - 30 MHz		
RE102	Electric Field	(1.5 MHz) -30 MHz - 5 GHz		
RS103	Electric Field	1.5 MHz - 5 GHz, 50 V/m equal for all frequencies		
	Radiated Susceptibility	2 MHz-80 Mhz 50V/m equal for all frequencies		
		80 MHz - 3 GHz 50V/m equal for all frequencies		
		3 GHz - 5 GHz, 50V/m equal for all frequencies		
EN61000-4-2	Electromagnetic Compatibility	Air discharge: 8 kV, Contact discharge: 6kV		

EN 61000-4-3	Electromagnetic Compatibility	0 V/m				
EN 61000-4-4	Electromagnetic Compatibility	Signal an	d DC-Net: 1 kV			
EN 61000-4-5	Electromagnetic Compatibility		ground potential 1kV, d DC-Net: 0.5 kV			
EN55022	Radio Disturbance	Class A				
* Option Test item: CS101/CS114/CS115/CS116/RS101/RS103/RE103/CE106						
MIL-STD-1275 Testing Methods						
Steady State	20V~33V					
Surge Low	18V/500ms					
Surge High	100V/500ms					
Others						
Reliability	No Moving Parts; Passive Cooling. Reliability Designed & Manufactured using ISO 9001/2005 Certified Quality Program.					
Operating Temp.	-40 to +70°C (ambient with air flow)		Operating Temp.			
Storage Temp.	-40 to +85°C		Storage Temp.			
Relative Humidity	5% to 95%, non-conde	ensing.	Relative Humidity			

## **Ordering Information**

#### THOR100-X4-D7E-D10

MIL-STD Fanless Rugged Computer with Intel® 9th Gen Xeon® E-2276ML, IP65 , with 10 MIL-DTL-D38999 Connectors, Operating Temp. -40 to 70°C

#### THOR100-X4-D7E-D9

MIL-STD Fanless Rugged Computer with Intel® 9th Gen Intel® Core i7-9850HL, IP65, with 9 MIL-DTL-D38999 Connectors, Operating Temp. -40 to 70°C

#### THOR100-X4-D7E

THOR100-X4-D7E Fanless Rugged Computer with Intel® 9th Gen Xeon® E-2276ML, IP65, with D38999 Connectors, Operating Temp. -40 to 70°C. Together with Rackmount brackets (To mount two computers side by side), I/O: 1 x DC-IN, 2 x LAN, 2 x DVI, 2 x USB3.0

## Front D38999 I/O



## **Rear D38999 I/0**

